



Source : IPC Status of Standardization ([www.ipc.org](http://www.ipc.org))

- IPC-8401– September 2024 – Guidelines for In-Mold Electronics
- IPC-HERMES-9852 Version 1.6 – July 2024 – The Global Standard for Machine-to-Machine Communication in SMT Assembly

Source : IPC Status of Standardization ([www.ipc.org](http://www.ipc.org))

- IPC-DR-DES-2022 – Juin 2023 – PCB Design Desk Reference 2022 Edition